

# **Fault Protection Switch with Current Foldback**

#### **Features**

- Up to ±100V Input Voltage Protection
- 4Ω On-resistance, Typical
- · Fast-switching Speed
- · No External Supplies Needed
- · Available in a SOT-89 package

#### **Applications**

- · Power Supplies
- · Fast Resettable Fuses
- · High-side Switches
- · Data Acquisition

### **General Description**

The FP0100 is a high-voltage Fault protection switch with current foldback. It is designed to protect system output power supplies against Overcurrent and Short-circuit conditions. In Protection mode, the FP0100 limits the current to  $300~\mu A$ .

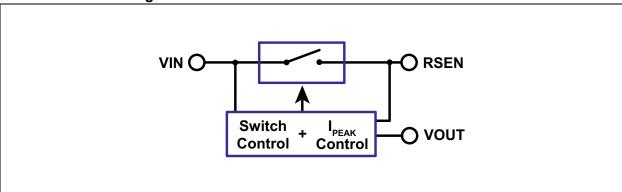
The FP0100 can be considered as a normally closed switch with a typical switch resistance of  $4\Omega.$  The peak current allowed to pass through the switch can be set by an external resistor across  $V_{OUT}$  and  $R_{SEN}.$  Once the voltage drop across  $V_{IN}$  and  $V_{OUT}$  exceeds a nominal value of 3V, the input current will foldback to 300  $\mu A.$  In the OFF state, the FP0100 can withstand up to 100V. Higher input voltages can be accommodated using an external Depletion-mode MOSFET. Refer to Figure 3-3 for more details.

#### **Package Type**

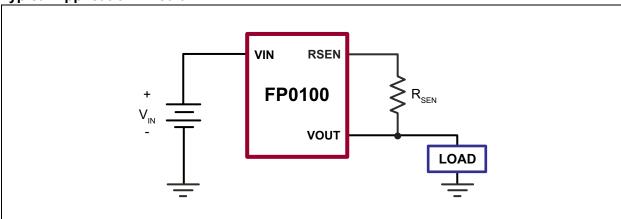


See Table 2-1 for pin information.

# **Functional Block Diagram**



# **Typical Application Circuit**



#### 1.0 ELECTRICAL CHARACTERISTICS

## **Absolute Maximum Ratings†**

Differential Voltage Drop, V <sub>IN-OUT</sub>	0V to +110V
Maximum Junction Temperature, T <sub>J</sub>	
Storage Temperature, T <sub>S</sub>	
Power Dissipation:	
SOT-89 (Note 1)	1.6W
ESD Rating (Note 2)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

Note 1: Mounted on an FR4 board, 25 mm x 25 mm x 1.57 mm

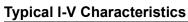
2: Device is ESD sensitive. Handling precautions are recommended.

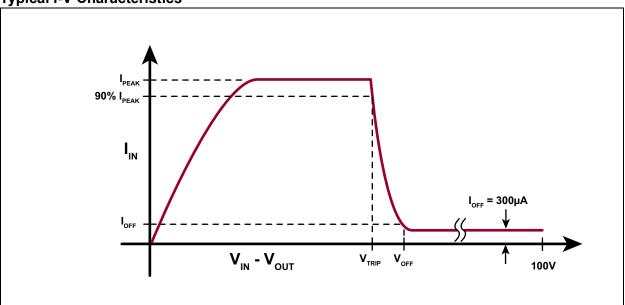
#### **ELECTRICAL CHARACTERISTICS**

Electrical Specifications: T <sub>J</sub> = 25°C unless otherwise specified.								
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions		
Differential Input Voltage Range	V <sub>IN</sub> –V <sub>OUT</sub>	0	_	100	V	V <sub>OUT</sub> = GND, I <sub>IN</sub> = 600 μA		
		_	260	_	mA	$R_{SEN} = 0\Omega$		
Peak Current	I <sub>PEAK</sub>		20	40	mA	$R_{SEN} = 50\Omega$		
			10	20	mA	$R_{SEN} = 100\Omega$		
Off Current	l <sub>OFF</sub>		300	600	μA	V <sub>IN</sub> -V <sub>OUT</sub> = 100V (See <b>Typical I-V Characteristics</b> .)		
On Resistance	R <sub>ON</sub>	_	4	6	Ω	$I_{IN}$ = 20 mA, $R_{SEN}$ = $0\Omega$		
V <sub>IN-OUT</sub> Trip Point to Turn Off	V <sub>TRIP</sub>	_	3	_	V	$R_{SEN} = 50\Omega$ , $I_{IN} = 90\%$ of $I_{PEAK}$ (See Typical I-V Characteristics.)		
Switch Turn-off Voltage	V <sub>OFF</sub>	_	_	4.5	V	I <sub>OFF</sub> ≤ 600 μA		

### **TEMPERATURE SPECIFICATIONS**

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Junction Temperature	$T_J$	-40	_	+125	°C	
Storage Temperature	T <sub>S</sub>	-65	_	+150	°C	
PACKAGE THERMAL RESISTANCE						
3-lead SOT-89	$\theta_{JA}$		133	_	°C/W	





# FP0100

### 2.0 PIN DESCRIPTION

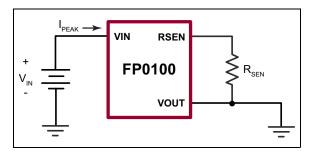
The details on the pins of FP0100 are listed in Table 2-1. See **Package Type** for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

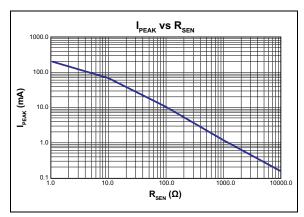
Pin Number	Pin Name	Description
1	VIN	Input Voltage
2, 4	VOUT	Output Voltage
3	RSEN	Current sense for $I_{PEAK}$ control. Connects to an external resistor across the RSEN and VOUT pins to set the $I_{PEAK}$ .

#### 3.0 FUNCTIONAL DESCRIPTION

The input peak current  $I_{PEAK}$  can be lowered by adding an external resistor across the  $R_{SEN}$  and  $V_{OUT}$  pins as shown in the test circuit in Figure 3-1.  $I_{PEAK}$  decreases as the resistor value of  $R_{SEN}$  increases. The typical  $I_{PEAK}$  vs.  $R_{SEN}$  characteristic is illustrated in Figure 3-2.



**FIGURE 3-1:** Test Circuit for  $I_{PEAK}$  vs.  $R_{SEN}$ .



**FIGURE 3-2:** Typical I<sub>PEAK</sub> vs. R<sub>SEN</sub> Characteristic.

The FP0100 has a typical response time of less than 30 ns. The short-circuit test setup is demonstrated in Figure 3-4. The output is at 60V prior to a short. A  $10\Omega$  resistor is used to measure the current going into the FP0100. A 220 nF ceramic capacitor is added to the input to supply any transient currents that might occur. The waveform is shown in Figure 3-5. Channel 1 is the output voltage which is discharged to 0V. Channel 2 is the voltage across the  $10\Omega$  resistor. The input current peaks to 400 mA and then decays quickly within 20 ns.

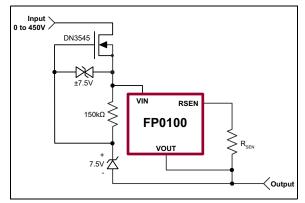


FIGURE 3-3: H

Higher Input Voltage

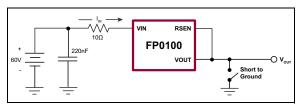


FIGURE 3-4: Short-circuit Test Performance.

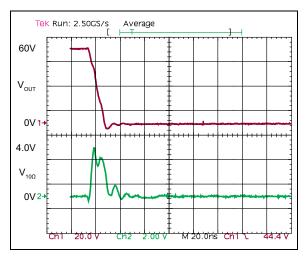
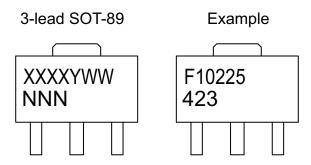


FIGURE 3-5: Waveforms.

Typical Short-circuit

#### 4.0 PACKAGING INFORMATION

## 4.1 Package Marking Information



Legend: XX...X Product Code or Customer-specific information
Year code (last digit of calendar year)

YY Year code (last 2 digits of calendar year)
WW Week code (week of January 1 is week '01')

NNN Alphanumeric traceability code

e3 Pb-free JEDEC® designator for Matte Tin (Sn)

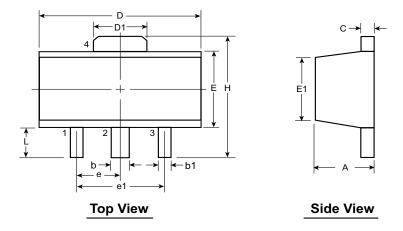
This package is Pb-free. The Pb-free JEDEC designator (e3)

can be found on the outer packaging for this package.

**Note**: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include

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# 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbo	ol	Α	b	b1	С	D	D1	Е	E1	е	e1	Н	L
	MIN	1.40	0.44	0.36	0.35	4.40	1.62	2.29	2.00†			3.94	0.73†
Dimensions (mm)	NOM	-	-	-	-	-		1.50 BSC	3.00 BSC	-	-		
()	MAX	1.60	0.56	0.48	0.44	4.60	1.83	2.60	2.29	200	200	4.25	1.20

JEDEC Registration TO-243, Variation AA, Issue C, July 1986. † This dimension differs from the JEDEC drawing Drawings not to scale.

D	N	1	Λ	N
	v		v	v

NOTES:

### APPENDIX A: REVISION HISTORY

### **Revision A (September 2022)**

- Converted Supertex Doc# DSFP-FP0100 to Microchip DS20005814A
- · Changed the package marking format
- Changed the 3-lead TO-243AA (SOT-89) package marking to 3-lead SOT-89 to align packaging specifications with the actual BQM
- Made minor text changes throughout the document

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To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO Device	<u>XX</u>     Packa   Optio		- X - X   Environmental Media Type	a) FP0100N8-G:	Fault Protection Switch with Current Foldback, 3-lead SOT-89, 2000/Reel
Device:	FP0100	=	Fault Protection Switch with Current Foldback		
Package:	N8	=	3-lead SOT-89		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	2000/Reel for an N8 Package		

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